

## High Performance Primary Side Regulation CV/CC Power Switch

## **FEATURES**

- Built-in 800V High Voltage Power BJT
- PSR Control, High Efficiency
- Multi-mode PSR Control
- Fast Dynamic Response
- Integrated Dynamic BJT Driving Circuit
- Optimized EMI Performance
- Audio Noise Free Operation
- CC and CV regulation ±5%
- Low Standby Power <30mW
- Cable Drop Compensation
- Build-in Protections:

APPLICATIONS

AC/DC Power Adapter

- Short Load Protection (FB SLP)
- Over Voltage Protection (FB OVP)
- Cycle-by-Cycle Current Limiting (OCP)
- On-Chip Thermal Shutdown (OTP)

Battery Chargers for Cellular Phones

- VDD OVP & UVP & Clamp
- Available with SOP7/SOP8 Package

## **GENERAL DESCRIPTION**

DP231X is a high performance Primary Side Regulation (PSR) PWM power switch with high precision CV/CC control ideal for charger applications , especially for low power off-line charger.

DP231X can achieve audio noise free operation and fast dynamic response. The built-in Cable Drop Compensation (CDC) function can provide excellent CV performance.

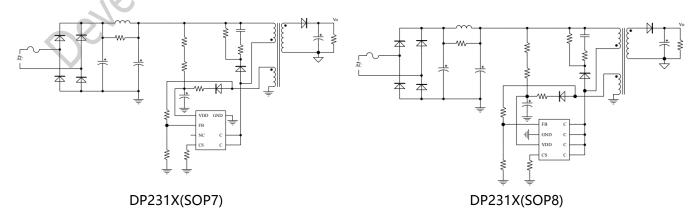
DP23X integrates functions and protections of VDD Under Voltage Lockout (UVLO), VDD over Voltage Protection (VDD OVP), Cycle-by-cycle Current Limiting (OCP), Short Load Protection (SLP), On-Chip Thermal Shutdown (OTP), VDD Clamping, etc.

DP231X also integrates single failure protections, including FB pull-up resistor open protection, FB pull-down resistor open protection, FB pull-down resistor short protection, output rectifier diode or SR open protection, output rectifier diode or SR short protection, transformer windings short protection and R<sub>cs</sub> open protection.

### PACKAGE

Name	Description		
DP231X	SOP7, Halogen free, Reel, 4000pc/reel		
	SOP8, Halogen free, Reel, 4000pc/reel		

## **TYPICAL APPLICATIONI CIRCUIT**



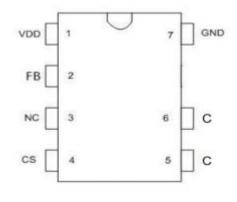
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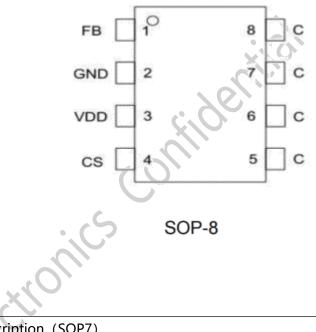
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## **PRODUCTS DESCRIPTION**

## > PIN CONFIGURATION





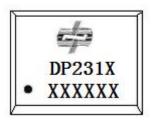
SOP-7

## > PIN DISCRIPTION

PIN Number	PIN Name	I/O	PIN Description (SOP7)
1	VDD	Р	IC Power supply pin
			System feedback pin which regulates both the output voltage in
2	FB	Ι.	CV mode and output current in CC mode based on the flyback
			voltage of the auxiliary winding.
3	NC	N'	No connect
4	CS	I	Current Sense Input Pin
5,6	С	Р	Internal Power BJT collector pin
7	GND	Р	IC Ground pin
	107		
PIN Number	PIN Name	I/O	PIN Description (SOP8)
0	1		System feedback pin which regulates both the output voltage in
1	FB	I	CV mode and output current in CC mode based on the flyback
			voltage of the auxiliary winding.
2	GND	Р	IC ground pin
3	VDD	Р	IC Power supply pin
4	CS	I	Current Sense Input Pin
5,6,7,8	С	0	Internal power BJT collector pin
4 5,6 7 PIN Number 1 2 3 4	CS C GND PIN Name FB GND VDD CS	P  /O         	Current Sense Input Pin Internal Power BJT collector pin IC Ground pin PIN Description (SOP8) System feedback pin which regulates both the output volta CV mode and output current in CC mode based on the flyb voltage of the auxiliary winding. IC ground pin IC Power supply pin Current Sense Input Pin



## > MARKING INFORMATION



DP231X for product name:

XXXXXX, the first X represents the last NO of year, 2014 is 4; The second X represents the month, in A-L 12 letters; The third and fourth X on behalf of the date, 01-31 said; The last X represents the wafer batch code.

### > TYPICAL OUTPUT POWER TABLE

Part Number	230VAC ± 15% <sup>(2)</sup>	85-265VAC
	Adapter ( <sup>3)</sup>	Adapter ( <sup>3)</sup>
DP2311	5W	3W
DP2313	8W	6W
DP2314	10W	7.5W
DP2315	12W	10W
DP2316	15W	12W

Note 1. The Max. output power is limited by junction temperature.

Note 2. 230VAC or 100/115VAC with voltage doubler.

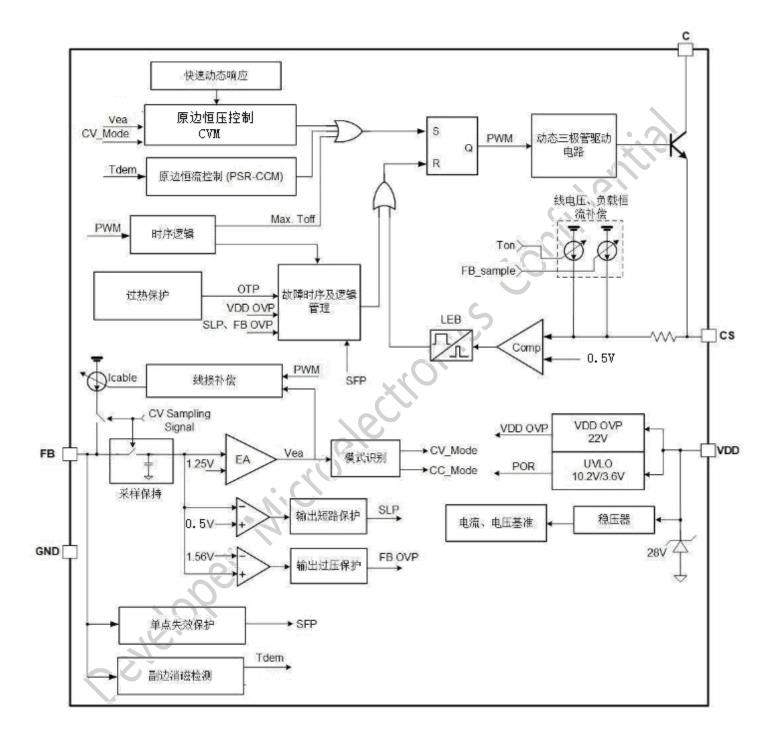
**Note 3.** Typical continuous power in a non-ventilated enclosed adapter with sufficient collector pattern as a heat sink at 50°C ambient.

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## **BLOCK DIAGRAM**





## ABSOLUTE MAXIMUM RATINGS<sup>(Note 4)</sup>

Parameter	Value	Unit
C Pin Voltage Range	-0.3 to 800	V
VDD DC Supply Voltage	-0.3 to 26	V
VDD DC Clamp Current	7	mA
CS Voltage Range	-0.3 to 7	V
FB Voltage Range	-0.7 to 7	V
Package Thermal ResistanceJunction to Ambient (SOP7/SOP8)	90	°C/W
Maximum Junction Temperature	165	°C
Storage Temperature Range	-65 to150	°C
Lead Temperature (Soldering, 10sec.)	260	°C
ESD Capability, HBM (Human Body Model)	3	KV

# **RECOMMENDED OPERATION CONDITIONS**

Value	Unit
5 to 21	V
-40 to 85	°C
70	kHz
35	kHz
	5 to 21 -40 to 85 70



## ELECTRICAL CHARACTERISTICS (TA= 25°C, VDD=16V, If not otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур.	Мах	Unit
Supply Voltage	e Section (VDD Pin)			I		
IVDD_st	Start-up current into VDD pin	VDD< VDD_ON	0.1	1.1	3	uA
IVDD_op	Operation Current			0.8	1.5	mA
IVDD_standby	Standby Current		0.16	0.26	0.36	mA
VDD_ON	VDD Under Voltage Lockout Exit		9	10	12	V
VDD_OFF	VDD Under Voltage Lockout Enter		3.4	3.8	4.2	V
VDD_OVP	VDD OVP Threshold		22	24	26	V
VDD_Clamp	VDD Zener Clamp Voltage	l(VDD ) = 7 mA	26	28	30	V
<b>Control Functi</b>	on Section (FB Pin)		~	L		
VFBREF	Internal Error Amplifier (EA) Reference Input	. 6	1.232	1.25	1.268	V
VFB_SLP	Short Load Protection (SLP) Threshold			0.5		V
VFB_OVP	FB Over Voltage Protection Threshold	X	1.48	1.56	1.64	V
TFB_short	Short Load Protection (SLP) (Note 5) Debounce Time			42		ms
TFB_OVP	FB Over Voltage Protection Debounce Time	(Note 5)		5		TSW
	Demagnetization Comparator Threshold	Upper Threshold		20		mV
VFB_dem		Lower Threshold		0		mV
	Leading Edge Blanking Time	CC Mode (Note 5)	3.6	4	4.4	us
Tblank		CV Mode (Note 5)	1.8	2	2.2	us
Ton_max	Maximum ON time	(Note 5)		25		us
Toff_max	Maximum OFF time			4.4		ms
ICable_max	Maximum Cable Drop Compensation(CDC) Current			48		uA
TSW/Tdem	Ratio between Switching Period and Demagnetization Time in CC Mode			2		
Current Sense	Input Section (CS Pin)					
TLEB	CS Input Leading Edge Blanking Time			450		ns
VCS(max)	Current limiting threshold		490	500	510	mV
VCS(min)	Current limiting threshold		184	200	216	mV

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DP231X



High Performance Primary Side Regulation CV/CC Power

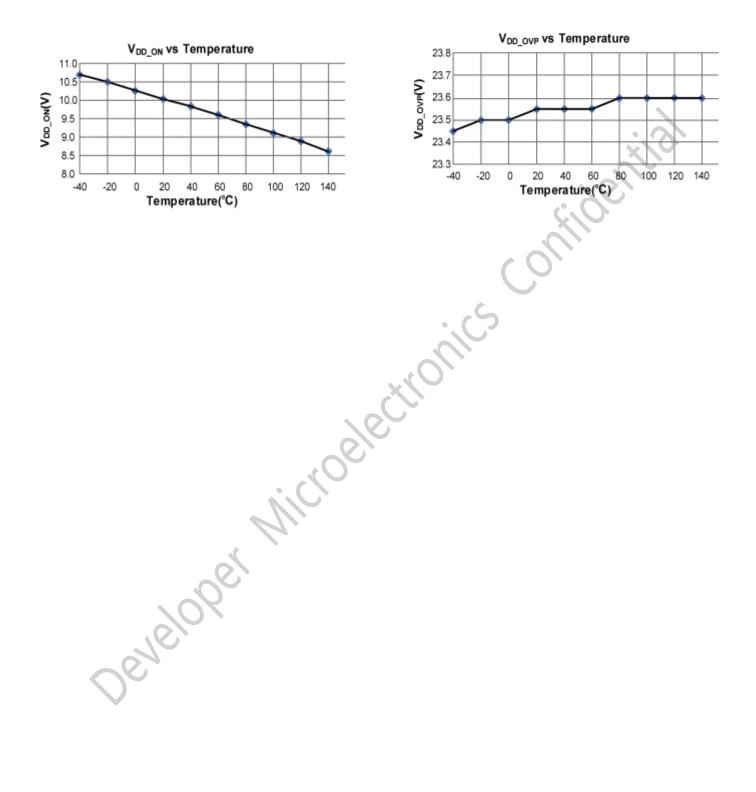
TD_OC	Over Current Detection and Control Delay			100		ns		
On-Chip Therr	mal Shutdown							
TSD	Thermal Shutdown	(Note 5)		160		°C		
TRC	Thermal Recovery	(Note 5)		135		°C		
Power BJT Sec	Power BJT Section (C Pin)							
		DP2311		0.35		А		
	Maximum DC Collector Current	DP2313		1.3	70.	А		
IC		DP2314		1.8		А		
		DP2315	c.	2.5		А		
		DP2316		4		А		
VCE(sat)	Collector-Emitter Saturation Voltage	IC=0.5A	$\mathbf{O}$	0.3		V		
HFE	DC Current Gain		15	20				
		DP2311	700			V		
		DP2313	700					
VCBO	Collector-Base Breakdown Voltage	DP2314	800					
		DP2315	800					
	10	DP2316	800					

Note4. Stresses listed as the above "Maximum Ratings" may cause permanent damage to the device. These are for stress ratings. Functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to maximum rating conditions for extended periods may remain possibility to affect device reliability. Note5. Guaranteed by the Design.

Developer



## CHARACTERIZATION PLOTS



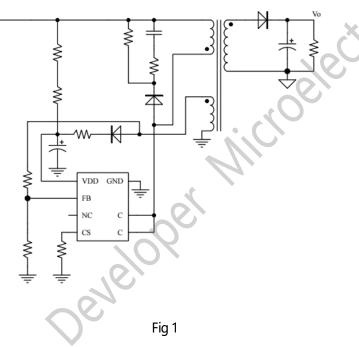


### **OPERATION DESCRIPTION**

DP231X is a high performance, multi-mode, Primary Side Regulation (PSR) power switch. The built-in high precision CV/CC control with high level protection features makes it suitable for offline small power converter applications

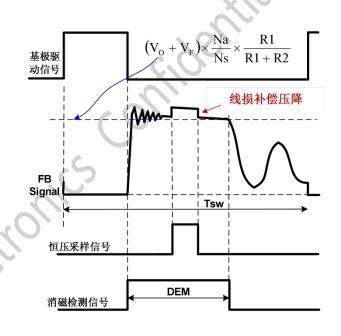
#### • System Start-Up Operation

Before the IC starts to work, it consumes only startup current (typically 1.1uA) which allows a large value startup resistor to be used to minimize the standby power loss. When VDD reaches turn-on voltage of 10V (typical), DP231X begins switching and the IC operation current is increased to be 0.26mA (typical). The hold-up capacitor continues to supply VDD before the auxiliary winding of the transformer takes control.



#### • PSR CV Modulation (PSR-CVM)

In Primary Side Regulation (PSR) control, the output voltage is sensed on the auxiliary winding during the transfer of transformer energy to the secondary. Fig.2 illustrates DP231X internal voltage sampling, the timing waveform of CV sampling signal, demagnetization signal (DEM). When the CV sampling process is over, the internal sample/hold (S&H) circuit captures the error signal and amplifies it through the internal Error Amplifier (EA). The output of EA is sent to the PSR CV Modulator (PSR-CVM) for CV regulation. The internal reference voltage for EA is trimmed to 1.25V with high accuracy.



#### Fig 2

During the CV sampling process, DP231X internal variable current source is flowing to FB pin for Cable Drop Compensation (CDC). Thus, there is a step at FB pin in the transformer demagnetization process, as shown in Fig.2. Fig.2 also illustrates the equation for "demagnetization plateau",

$$V_{FB} = \left(V_{o} + V_{F}\right) \times \frac{Na}{Ns} \times \frac{R1}{R1 + R2}$$

Where Vo and VF is the output voltage and diode forward voltage; R1 and R2 is the resistor divider connected from the auxiliary winding to FB Pin, Ns and Na is secondary winding and auxiliary winding respectively.

When heavy load condition, the Mode Selector (as

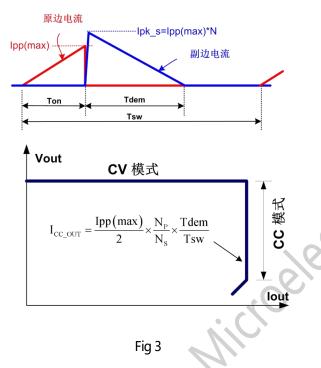


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shown in "**Block Diagram**") based on EA output will switch to CC Mode automatically.

#### • PSR CV Modulation (PSR-CVM)

Timing information at the FB pin and current information at the CS pin allow accurate regulation of the secondary average current. The control law dictates that as power is increased in CV regulation and approaching CC regulation the primary peak current is at Ipp (max), as shown in Fig.3.



Referring to Fig.3 above, the primary peak current, transformer turns ratio, secondary demagnetization time (Tdem), and switching period (Tsw) determines the secondary average output current lout. Ignoring leakage inductance effects, the equation for average output current is shown in Fig.3. When the average output current lout reaches the regulation reference in the Primary Side Constant Current Modulator (PSR-CCM) block, the IC operates in pulse frequency modulation (PFM) mode to control the output current at any output voltage at or below the voltage regulation target as long as the auxiliary winding can keep VDD above the UVLO turn-off threshold.

In DP231X, the ratio between Tdem and Tsw in CC mode is 1/2. Therefore, the average output current

can be expressed as:

$$I_{cc\_out}(mA) \cong \frac{1}{4} \times N \times \frac{500 mV}{Rcs(\Omega)}$$

In the equation above,

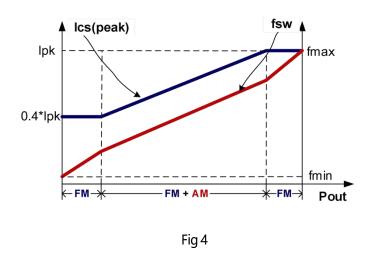
N----The turn ratio of primary side winding to secondary side winding.

Rcs--- the sensing resistor connected between the power BJT emitter to GND.

### • Multi-Mode Control in CV Mode

To meet the tight requirement of averaged system efficiency and no-load power consumption, a hybrid of frequency modulation (FM) and amplitude modulation (AM) is adopted in DP231X which is shown in the Fig 4.

Around the full load, the system operates in FM mode. When normal to light load conditions, the IC operates in FM+AM mode to achieve excellent regulation and high efficiency. When the system is near zero loading, the IC operates in FM again for standby power reduction. In this way, the no-load consumption can be less than 30mW

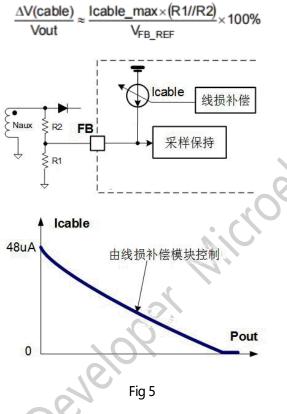


• Cable Drop Compensation (CDC) in CV Mode

**DP231X** 



In smart phone charger application, the battery is always connected to the adapter with a cable wire which can cause several percentages of voltage drop on the actual battery voltage. In DP231X, an offset voltage is generated at FB pin by an internal current source (modulated by CDC block, as shown in Fig.5) flowing into the resistor divider. The current is proportional to the switching period; thus, it is inversely proportional to the output power Pout. Therefore, the drop due the cable loss can be compensated. As the load decreases from full loading to zero loading, the offset voltage at FB pin will increase. The percentage of maximum compensation is given by:



For example,  $R1=2K\Omega$ ,  $R2=16K\Omega$ , The percentage of maximum compensation is given by

$$\frac{\Delta V(\text{cable})}{V \text{out}} \approx \frac{48u \times (16k/2k)}{1.25} \times 100\% = 6.83\%$$

#### • Fast Dynamic Response

In DP231X, the dynamic response performance is

optimized to meet USB charge requirements.

#### • Single Failure Protections for Power Supply

DP231X integrates single failure protections, including FB pull-up resistor open protection, FB pull-down resistor open protection, FB pull-down resistor short protection, output rectifier diode or SR open protection, output rectifier diode or SR short protection, transformer windings short protection and Rcs open protection. This function can ensure there is no damage to IC and no over voltage of output.

#### • On Chip Thermal Shutdown (OTP)

When the IC temperature is over 160°C, the IC shuts down. Only when the IC temperature drops to 135°C, IC will restart

#### Audio Noise Free Operation

As mentioned above, the multi-mode CV control with a hybrid of FM and AM provides frequency modulation is used in CV mode. An internal current source flowing to CS pin makes CS peak voltage modulation realized. In DP231X, the optimized combination of frequency modulation and CS peak voltage modulation algorithm can provide audio noise free operation from full loading to zero loading.

#### • Dynamic BJT Base Drive

DP231X integrates a dynamic base drive control to optimize efficiency. The BJT base drive current is dynamically controlled according to the power supply load change. The higher the output power, the higher the based current.

#### • Short Load Protection (FB SLP)

In DP231X, the output is sampled on FB pin and then compared with a threshold of UVP (0.5V typically).

In DP231X, when sensed FB voltage is below 0.5V and hold 42ms, the IC will enter into Short Load Protection (SLP) mode, in which the IC will enter into auto recovery protection mode

#### • FB Over Voltage Protection (FB OVP)

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In DP231X, the output is sampled on FB pin and then compared with a threshold of OVP (1.56V typically).

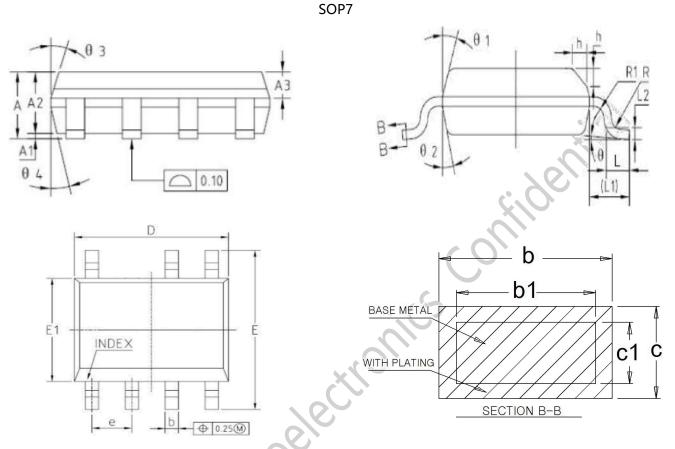
When sensed FB voltage is above 1.56V for more than 5 cycles, the IC will enter into Over Voltage Protection (OVP) mode, in which the IC will enter into auto recovery protection mode

#### VDD Over Voltage Protection (OVP) and Zener • Clamp

When VDD voltage is higher than 24V (typical), the IC will stop switching. This will cause VDD fall al in An irated to p. Confidentia Confidentia Confidentia Confidentia Confidentia down to be lower than  $V_{DD OFF}$  (typical 3.8V) and then the system will restart up again. An internal 28V (typical) zener clamp is integrated to prevent the IC



## PACKAGE DIMENSION



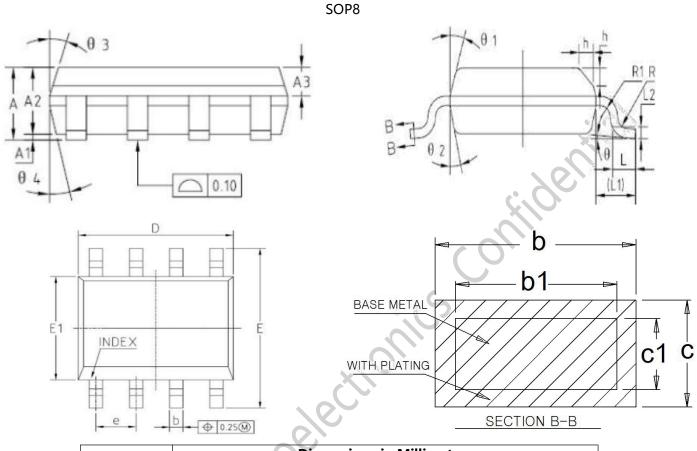
Symbol	<b>Dimensions in Millimeters</b>			
Symbol	Min	Nom	Max	
A	1.45	1.55	1.65	
A1	0.10	0.15	0.20	
A2	1.353	1.40	1.453	
A3	0.55	0.60	0.65	
b	0.38	-	0.51	
b1	0.37	0.42	0.47	
c	0.17	-	0.25	
<b>c</b> 1	0.17	0.20	0.23	
D	4.85	4.90	4.95	
E	5.85	600	6.15	
E1	3.85	3.90	3.95	
е	1.245	1.27	1.295	
L	0.45	0.60	0.75	
L1	-	1.040REF	-	
L2	-	0.250BSC	-	
Θ1-Θ4	12° REF			
h	0.40REF			
R	0.15° REF			
R1	0.15° REF			

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## PACKAGE DIMENSION



Symbol	Dir	Dimensions in Millimeters			
Symbol	Min	Nom	Max		
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A1	0.10	0.15	0.20		
A2	1.353	1.40	1.453		
A3	0.55	0.60	0.65		
b	0.38	-	0.51		
b1	0.37	0.42	0.47		
С	0.17	-	0.25		
c1	0.17	0.20	0.23		
D	4.85	4.90	4.95		
E	5.85	600	6.15		
E1	3.85	3.90	3.95		
e	1.245	1.27	1.295		
L	0.45	0.60	0.75		
L1	-	1.040REF	-		
L2	-	0.250BSC	-		
Θ1-Θ4		12° REF			
h		0.40REF			
R		0.15° REF			
R1		0.15° REF			

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